(0408)

## RF PERFORMANCE

INSERTION LOSS CHAR, S21


FREQUENCY (GHz)

## Attachment Method

- Compatible with epoxy and AuSn solder attachment.
- Bonding can be done with either needle or automatic dispensers.
- For epoxy curing, refer to epoxy manufacturer's preferred schedule, but it's typically in the range of 125 to $150^{\circ} \mathrm{C}$.

